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nveying party(ies): arszalek, Daniel Horvath e(s) of conveying party(ies) attached?	2. Name and address of receiving party(ies): Name: Sennco Solutions, Inc.
nveying party(ies): arszalek, Daniel Horvath e(s) of conveying party(ies) attached?	Name and address of receiving party(ies): Name: Sennco Solutions, Inc.
e(s) of conveying party(ies) attached?	
	Additional Name(s) & Address(es) attached □ Yes ■ No
Agreement Change of Name	1.8. PTO
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(number(s) or patent number(s): ATT	ORNEY DOCKET NO.: SEN-P-05-007
nt is being filed together with a new ap	pplication, the execution date of the application is:
pplication No.(s): Unassigned	B: Patent No.(s)
Additional n	umbers attached: No
	Total number of applications and patents involved -1-
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PATENT REEL: 017327 FRAME: 0756

ASSIGNMENT

FOR a valuable consideration, the undersigned, Christopher Marszalek, residing in Plainfield, Illinois, and Daniel Horvath, residing in Marseilles, Illinois, hereby sells, assigns and transfers unto SENNCO SOLUTIONS, INC., an Illinois corporation, the whole right, title and interest in and to a certain invention or improvement in an invention entitled:

"SYSTEM AND METHOD FOR SECURING AND/OR FOR ALIGNING A DEVICE"

and disclosed in an application for Letters Patent of the United States, prepared by the firm of Patents+TMS, a Professional Corporation of Chicago, Illinois, and executed of even date herewith, said application being identified in the office records of said firm as Case No. SEN-P-05-007 and in and to the United States Letters Patent therefor, when issued, together with all improvements thereon and betterments thereof, all divisions, continuations and reissues thereof and substitutions of or for said application, and all rights and privileges under the Letters Patent that may be granted therefor, including the right to claim the benefit of an earlier filing date for the same invention in a foreign country.

I hereby authorize and request the Commissioner of Patents to issue the Letters Patent that may be granted for said invention or improvement to SENNCO SOLUTIONS, INC.

For the same consideration, I hereby agree that I will promptly communicate to the aforesaid assignee or its assigns full and complete information concerning said improvements or betterments of the inventions disclosed in said application, and will cooperate at any time upon request of said assignee or its assigns, at its expense, in the procurement of patent protection to cover the inventions herein assigned and to be assigned, including the execution of new, divisional, continuing and reissue applications; will make all rightful oaths, will testify in any proceedings in the United States Patent Office or in the Courts, and generally will do everything lawfully possible to aid said assignee, its successors, assigns and nominees to obtain, enjoy and enforce proper patent protection for the inventions embraced within the terms of this document.

Date: //-23-05

RECORDED: 12/05/2005

Daniel Horvath

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